FOr M PTQ-1595 (Rev. 6-93) 09-11-20	001 EET U.S. DEPARTMENT OF COMMERCE			
OMB No. 0651-0011 (exp. 4/94)  Tab settings ⇒ ⇒ ▼ ▼	Patent and Trademark Office  ▼ E L 46-57823-55			
To the Honorable Commissioner of P 1018399				
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):			
John T. Moore	Name: Micron Technology, Inc.			
Scott J. DeBoer	Internal Address:			
Additional name(s) of conveying party(ies) attached? Yes X No	200 000 000 000 000 000 000 000 000 000			
3. Nature of conveyance:				
X Assignment	Street Address: 8000 South Federal Way			
Security Agreement Change of Name				
Other	City: Boise State: ID ZIP: 83716			
Execution Date: August 20, 2001	Additional name(s) & address(es) attached?			
A. Patent Application No.(s) 9/05/2001 MMEKONEN 00000047 09943180 FC:581 40.00 OP  Additional numbers attack	B. Patent No.(s)			
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:			
Name: Mark S. Matkin	7. Total fee (37 CFR 3.41) \$ 40.00			
Internal Address: Wells, St. John, Roberts, Gregory				
& Matkin P.S.	X Enclosed			
	Authorized to be charged to deposit account			
Street Address: 601 West First Avenue, Suite 1300	8. Deposit account number:			
City: Spokane State: WA ZIP: 99201-3828	23-0925  (Attach duplicate copy of this page if paying by deposit account)			
	USE THIS SPACE			
9. Statement and signature.  To the best of my knowledge and belief, the foregoing inform the original document.	ation is true and correct and any attached copy is a true copy of			
Mark S. Matkin	8-29-01			
Name of Person Signing	Signature Date over sheet, attachments, and document:			
rotal number of pages including co	ver sheet, attachments, and accument.			

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

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(Form PTO--1595--Recordation Form Cover Sheet - page 1 of 3)

## ASSIGNMENT

## PARTIES TO THE ASSIGNMENT:

#### INVENTORS:

John T. Moore Scott J. DeBoer

#### ASSIGNEE:

Micron Technology, Inc. Corporation of the State of Delaware 8000 South Federal Way Boise, Idaho 83716

### BACKGROUND OF THIS ASSIGNMENT:

INVENTORS have conceived certain new and useful inventions disclosed in a United States patent application titled "Capacitors, Methods of Forming Capacitors, and Methods of Forming Capacitor Dielectric Layers".

MICRON TECHNOLOGY, INC. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

# THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt sufficiency and adequacy of which is hereby acknowledged, INVENTORS hereby sell, assign and transfer to ASSIGNEE the entire right, title and interest in the above-identified application executed currently with this assignment and to any reissues, renewals, divisions or continuations thereof,

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and hereby authorizes the Commissioner of Patents and Trademarks to issue such Letters Patent to ASSIGNEE for the sole use of ASSIGNEE, its successors or assigns.

INVENTORS further agree to execute, at the request and expense of ASSIGNEE such other formal documents as may be required to fully convey the interest transferred herein and will similarly execute any application papers required for the filing of any division, continuation, renewal or reissue of the patent application or resulting Letters Patent; and will generally do everything necessary or desirable to obtain and enforce proper protection for the inventions assigned hereby.

INVENTORS further assign to ASSIGNEE the whole right, title and interest in the inventions disclosed in the application throughout all countries foreign to the United States. ASSIGNEE is hereby authorized to apply for patents relating to the inventions in its own name in countries where such procedure is proper; to claim the benefit of the International Convention; to file and prosecute International Applications relating to the inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute applications relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting

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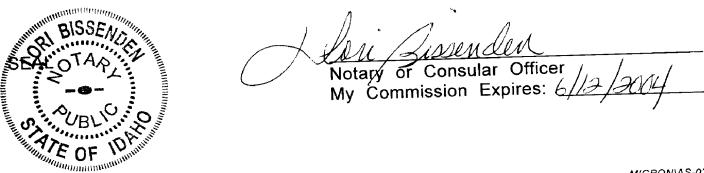
Letters Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent.

INVENTORS further warrant and covenant that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full rights to convey the same as herein expressed is possessed by the undersigned.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignees.

Dated: \$\frac{1}{2001}		Signature:	John T. Moore	WZ.
State of <u>Idaho</u> County of <u>Ada</u>		) ) ss. )		
	a s th	$\Lambda$ .		2004 personally

BEFORE ME, this 201 day of Mugust, 2001 personally appeared the above-named inventor, known to me to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her own free will for the purpose therein expressed.



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Dated: Signature	Scott J. DeBoer		
State of <u>Idaho</u> ) ss.			
County of Ada ) ss.			
BEFORE ME, this			
SEAL MINING OF DAY MAN COME	Sunden r Consular Officer mission Expires: 6/13/3004		

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**RECORDED: 08/29/2001**